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Attorney Docket No. 0756-7782

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Shunpei YAMAZAKI et al.

Serial No. 10/587,744

Filed: July 28, 2006

For: METHOD FOR MANUFACTURING
THIN FILM INTEGRATED CIRCUIT,
AND ELEMENT SUBSTRATE

) Group Art Unit: 2823

) Examiner: Su Jya Fan

) CERTIFICATE OF MAILING

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AMENDMENT

Honorable Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action dated February 20, 2009, please consider the following amendments and remarks in connection with the above-identified application.

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks begin on page 10 of this paper.